

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT3953080

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YOUNG-JAE LIM	05/24/2016
SANG-HOON LEE	05/20/2016
JONG-YOO KIM	05/20/2016
HAK-SUB KIM	05/20/2016
SANG-JOON PARK	05/23/2016
HEE-SEOK OH	05/20/2016
SO-YEON LEE	05/24/2016
KYO-IL CHUNG	05/24/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE
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<b>Name:</b>	UNIVERSITY-INDUSTRY FOUNDATION, YONSEI UNIVERSITY
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15205149
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(703)854-1332
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	703-854-1331
<b>Email:</b>	mail@lrkpatent.com
<b>Correspondent Name:</b>	LRK PATENT LAW FIRM
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<b>PATENT</b>	

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<b>ATTORNEY DOCKET NUMBER:</b>	P11244US
<b>NAME OF SUBMITTER:</b>	TAEKSOO LEE
<b>SIGNATURE:</b>	/Taeksoo Lee/
<b>DATE SIGNED:</b>	07/08/2016
<b>Total Attachments: 5</b> source=P11244_dec_asn#page1.tif source=P11244_dec_asn#page2.tif source=P11244_dec_asn#page3.tif source=P11244_dec_asn#page4.tif source=P11244_dec_asn#page5.tif	

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING  
AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR MULTIPLE ASSIGNEES**

**Title of  
Invention**

**FITNESS DEVICE-BASED SIMULATOR AND SIMULATION METHOD  
USING THE SAME**

As the below named inventor, I hereby declare that:

This declaration ☒ The attached application, or  
is directed to: ☐ United States application or PCT international application number \_\_\_\_\_  
filed on \_\_\_\_\_.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, **ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE** (hereinafter referred to as "ASSIGNEES") having places of business at: **218, Gajeong-ro, Yuseong-gu, Daejeon 34129, Republic of Korea**, and **UNIVERSITY-INDUSTRY FOUNDATION, YONSEI UNIVERSITY** (hereinafter referred to as "ASSIGNEES") having places of business at: **Yonsei University, 50, Yonsei-ro, Seodaemun-gu, Seoul 03722, Republic of Korea**, respectively, are desirous of becoming joint owners with each having an equal undivided interest, and are hereinafter known as the ASSIGNEES, are desirous of acquiring the entire right, title and interest for the United States and its territorial possessions in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, I hereby assign, sell and transfer to said ASSIGNEES, their assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States and its territorial possessions including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor, said ASSIGNEES and their assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEES and their assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as I might or could have held and enjoyed the same, if this assignment had not been made.

I hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEES, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

I hereby authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEES, their assigns and legal representatives, in accordance herewith.

I hereby grant LRK Patent Law Firm the power to insert any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

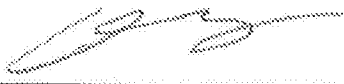
IN TESTIMONY WHEREOF, this assignment is executed by me, on the respective date(s) indicated below.

LEGAL NAME OF INVENTOR

Inventor: LIM, Young-Jae

Date: May 24, 2016

Signature: \_\_\_\_\_



Check the box below and complete the attached page(s) to list additional inventors.

☒ Additional inventors are being named on the 3 supplemental sheet(s) attached hereto.

**LRK PATENT LAW FIRM**

1952 Gallows Rd. Suite 200

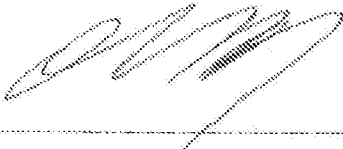
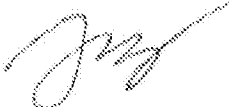

Vienna, VA 22182

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**SUPPLEMENTAL SHEET FOR DECLARATION USING  
AN APPLICATION DATA SHEET AND ASSIGNMENT**

**ADDITIONAL INVENTOR(S)**  
Supplemental Sheet


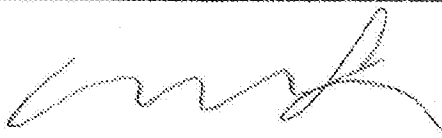
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<b>Legal Name of Joint Inventor, if any:</b>	
Inventor's Name	LEE, Sang-Hoon
Inventor's Signature	
Date (Optional)	May 20, 2016
<b>Legal Name of Joint Inventor, if any:</b>	
Inventor's Name	KIM, Jong-Yoo
Inventor's Signature	
Date (Optional)	May 20, 2016
<b>Legal Name of Joint Inventor, if any:</b>	
Inventor's Name	KIM, Hak-Sub
Inventor's Signature	
Date (Optional)	May 20, 2016

**SUPPLEMENTAL SHEET FOR DECLARATION USING  
AN APPLICATION DATA SHEET AND ASSIGNMENT**

**ADDITIONAL INVENTOR(S)  
Supplemental Sheet**

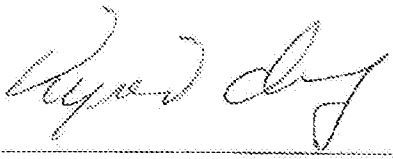
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<b>Legal Name of Joint Inventor, if any:</b>	
Inventor's Name	PARK, Sang-Joon
Inventor's Signature	
Date (Optional)	May 23, 2016
<b>Legal Name of Joint Inventor, if any:</b>	
Inventor's Name	OH, Hee-Seok
Inventor's Signature	
Date (Optional)	May 20, 2016
<b>Legal Name of Joint Inventor, if any:</b>	
Inventor's Name	LEE, So-Yeon
Inventor's Signature	Lee So Yeon
Date (Optional)	24 May, 2016

**SUPPLEMENTAL SHEET FOR DECLARATION USING  
AN APPLICATION DATA SHEET AND ASSIGNMENT**

**ADDITIONAL INVENTOR(S)**  
**Supplemental Sheet**

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<b>Legal Name of Joint Inventor, if any:</b>	
Inventor's Name	CHUNG, Kyo-Il
Inventor's Signature	
Date (Optional)	24. May. 2016